

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT4089135

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
STEPHEN R. FORREST	07/14/2016
KYUSANG LEE	07/14/2016
RECEIVING PARTY DATA	
Name:	THE REGENTS OF THE UNIVERSITY OF MICHIGAN
Street Address:	1600 HURON PARKWAY
Internal Address:	2ND FLOOR
City:	ANN ARBOR
State/Country:	MICHIGAN
Postal Code:	48109-2590
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15101287
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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Email:	tack@reising.com
Correspondent Name:	JAMES D. STEVENS REISING ETHINGTON P.C.
Address Line 1:	P.O. BOX 4390
Address Line 4:	TROY, MICHIGAN 48099
ATTORNEY DOCKET NUMBER:	7935-3098-3
NAME OF SUBMITTER:	PAULA TACK
SIGNATURE:	/paula tack/
DATE SIGNED:	10/09/2016
Total Attachments: 1	
source=Assignment-signed#page1.tif	

ASSIGNMENT

For the sum of One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, the undersigned:

Stephen R. FORREST, residing at 336 Rock Creek Court, Ann Arbor, MI 48104
[Full Name of Assignor #1] [Residence Address]

Kyusang LEE, residing at 3544 Greenbrier Blvd. Apt 424A, Ann Arbor, MI 48105
[Full Name of Assignor #2] [Residence Address]

_____, residing at _____
[Full Name of Assignor #3] [Residence Address]

_____, residing at _____
[Full Name of Assignor #4] [Residence Address]

do hereby assign, sell and set over to:

The Regents of The University of Michigan, located at
[Full Legal Name of Assignee]
1600 Huron Parkway, 2nd Floor, Ann Arbor, MI 48109-2590
[Assignee's Address]

(hereinafter referred to as Assignee), its successors, assigns or other legal representatives, the entire right, title and interest, domestic and foreign, in and to any and all patent rights covering inventions and discoveries set forth in the application for United States Letters patent, entitled:

FABRICATION OF THIN-FILM ELECTRONIC DEVICES WITH NON-DESTRUCTIVE WAFER REUSE
[Patent Application Title]

including, but not limited to, the entire right, title and interest in the following patent application(s):

Application No. 61/910,645, filed December 2, 2013,

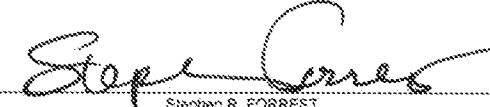
Application No. PCT/US2014/068197, filed December 2, 2014,

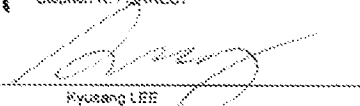
Application No. 15/101,287, filed June 2, 2016,

including the right of said Assignee, its successors, assigns or other legal representatives to make applications, including original, continuation, and divisional applications, and to receive Letters Patent covering said inventions and discoveries in the United States and in any and all foreign countries. And the undersigned hereby assign, sell and set over to said Assignee, its successors, assigns or other legal representatives, all rights of priority in and to said patent applications in all countries. The Assignee and its agents are authorized to insert the Serial Number and Filing Date of any such patent application(s) in the spaces provided above.

The undersigned hereby represent and warrant that no rights have been granted that are inconsistent with the rights being granted herein. Further, the undersigned hereby agree to execute any and all papers, including applications for Letters Patent of any and all kinds and in any and all countries and to perform any and all acts which said Assignee, its successors, assigns or other legal representatives may deem necessary to secure thereto the rights herein assigned, sold and set over.

Date: 7-14-2016



Stephen R. FORREST


Kyusang LEE

Return to James D. Stevens at Reising Ethington P.C., PO Box 4390, Troy, Michigan USA 48069-4390